

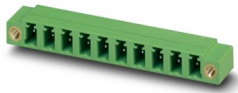
# MC 1,5/10-GF-5,08 - PCB header



1847547

<https://www.phoenixcontact.com/us/products/1847547>

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PCB headers, nominal cross section: 1.5 mm<sup>2</sup>, color: green, nominal current: 8 A, rated voltage (III/2): 320 V, contact surface: Tin, contact connection type: Pin, number of potentials: 10, number of rows: 1, number of positions: 10, number of connections: 10, product range: MC 1,5/..-GF, pitch: 5.08 mm, mounting: Wave soldering, pin layout: Linear pinning, solder pin [P]: 3.4 mm, number of solder pins per potential: 1, plug-in system: COMBICON MC 1,5, Pin connector pattern alignment: Standard, locking: Screw locking mechanism, mounting: Threaded flange, type of packaging: packed in cardboard

## Your advantages

- Well-known mounting principle allows worldwide use
- Screwable flange for superior mechanical stability
- Maximum flexibility when it comes to device design – one header for connectors with different connection technologies

## Commercial data

Item number	1847547
Packing unit	50 pc
Minimum order quantity	50 pc
Sales key	AA02
Product key	AABSCB
Catalog page	Page 249 (C-1-2013)
GTIN	4017918102807
Weight per piece (including packing)	4.89 g
Weight per piece (excluding packing)	4.07 g
Customs tariff number	85366930
Country of origin	DE

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## Technical data

### Product properties

Product type	PCB headers
Product family	MC 1,5/..-GF
Product line	COMBICON Connectors S
Type	Standard
Number of positions	10
Pitch	5.08 mm
Number of connections	10
Number of rows	1
Number of potentials	10
Mounting flange	Threaded flange
Pin layout	Linear pinning
Solder pins per potential	1

### Electrical properties

Nominal current $I_N$	8 A
Nominal voltage $U_N$	320 V
Degree of pollution	3
Contact resistance	1.2 m $\Omega$
Rated voltage (III/3)	250 V
Rated surge voltage (III/3)	4 kV
Rated voltage (III/2)	320 V
Rated surge voltage (III/2)	4 kV
Rated voltage (II/2)	400 V
Rated surge voltage (II/2)	4 kV

### Mounting

Mounting type	Wave soldering
Pin layout	Linear pinning

### Flange

Tightening torque	0.3 Nm
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### Material specifications

#### Material data - contact

Note	WEEE/RoHS-compliant, free of whiskers according to IEC 60068-2-82/JEDEC JESD 201
Contact material	Cu alloy
Surface characteristics	Tin-plated
Metal surface contact area (top layer)	Tin (3 - 5 $\mu\text{m}$ Sn)
Metal surface contact area (middle layer)	Nickel (1 - 3 $\mu\text{m}$ Ni)
Metal surface soldering area (top layer)	Tin (3 - 5 $\mu\text{m}$ Sn)

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Metal surface soldering area (middle layer)	Nickel (1 - 3 µm Ni)
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## Material data - housing

Color (Housing)	green (6021)
Insulating material	PBT
Insulating material group	IIIa
CTI according to IEC 60112	225
Flammability rating according to UL 94	V0

## Dimensions

Dimensional drawing	
Pitch	5.08 mm
Width [w]	59.92 mm
Height [h]	10.65 mm
Length [l]	9.2 mm
Installed height	7.25 mm
Solder pin length [P]	3.4 mm
Pin dimensions	0.8 x 0.8 mm

## PCB design

Hole diameter	1.2 mm
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## Mechanical tests

### Visual inspection

Specification	IEC 60512-1-1:2002-02
Result	Test passed

### Dimension check

Specification	IEC 60512-1-2:2002-02
Result	Test passed

### Resistance of inscriptions

Specification	IEC 60068-2-70:1995-12
Result	Test passed

### Polarization and coding

Specification	IEC 60512-13-5:2006-02
Result	Test passed

### Contact holder in insert

Specification	IEC 60512-15-1:2008-05
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Contact holder in insert Requirements >20 N	Test passed
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## Insertion and withdrawal forces

Result	Test passed
No. of cycles	25
Insertion strength per pos. approx.	8 N
Withdraw strength per pos. approx.	5 N

## Electrical tests

### Thermal test | Test group C

Specification	IEC 60512-5-1:2002-02
Tested number of positions	12

### Insulation resistance

Specification	IEC 60512-3-1:2002-02
Insulation resistance, neighboring positions	> 5 MΩ

### Air clearances and creepage distances |

Specification	IEC 60664-1:2007-04
Insulating material group	IIIa
Comparative tracking index (IEC 60112)	CTI 225
Rated insulation voltage (III/3)	250 V
Rated surge voltage (III/3)	4 kV
minimum clearance value - non-homogenous field (III/3)	3 mm
minimum creepage distance (III/3)	4 mm
Rated insulation voltage (III/2)	320 V
Rated surge voltage (III/2)	4 kV
minimum clearance value - non-homogenous field (III/2)	3 mm
minimum creepage distance (III/2)	3.2 mm
Rated insulation voltage (II/2)	400 V
Rated surge voltage (II/2)	4 kV
minimum clearance value - non-homogenous field (II/2)	3 mm
minimum creepage distance (II/2)	4 mm

## Environmental and real-life conditions

### Vibration test

Specification	IEC 60068-2-6:2007-12
Frequency	10 - 150 - 10 Hz
Sweep speed	1 octave/min
Amplitude	0.35 mm (10 Hz ... 60.1 Hz)
Acceleration	5g (60.1 Hz ... 150 Hz)
Test duration per axis	2.5 h

### Durability test

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Specification	IEC 60512-9-1:2010-03
Impulse withstand voltage at sea level	4.8 kV
Contact resistance R <sub>1</sub>	1.2 mΩ
Contact resistance R <sub>2</sub>	1.4 mΩ
Insertion/withdrawal cycles	25

## Climatic test

Specification	ISO 6988:1985-02
Corrosive stress	0.2 dm <sup>3</sup> SO <sub>2</sub> on 300 dm <sup>3</sup> /40 °C/1 cycle
Thermal stress	100 °C/168 h
Power-frequency withstand voltage	2.21 kV

## Shocks

Specification	IEC 60068-2-27:2008-02
Pulse shape	Half-sine
Acceleration	30g
Shock duration	18 ms
Test directions	X-, Y- and Z-axis (pos. and neg.)

## Ambient conditions

Ambient temperature (operation)	-40 °C ... 100 °C (dependent on the derating curve)
Ambient temperature (storage/transport)	-40 °C ... 70 °C
Relative humidity (storage/transport)	30 % ... 70 %
Ambient temperature (assembly)	-5 °C ... 100 °C

## Packaging specifications

Type of packaging	packed in cardboard
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